## Specification for Approval

• DEVICE NUMBER: BL-B2441T-AT

SAMPLES ATTACHED AREA

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PAGE DATE	1	2	3	4	5			4	*	CONTENTS
2009/6/10	1.0	1.0	1.0							Original Released
2015/6/15	1.1	1.1	1.1	1.1	1.1					Modify
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#### FOR CUSTOMER'S APPROVAL STAMP OR SIGNATURE

	APPROVED	PURCHASE	MANUFACTURE	QUALITY	ENGINEERING
A					

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BL-B2441T-AT

#### Features:

1. Chip material: GaP/GaP

2. Emitted color: Green

3. Lens Appearance: Green Trans

4. Low power consumption.

5. High efficiency.

6. Versatile mounting on P.C. Board or panel.

7. Low current requirement.

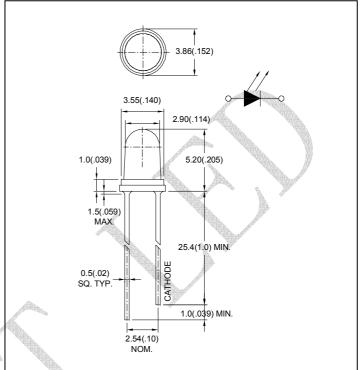
8. 3 mm diameter package.

9. This product don't contained restriction substance, compliance ROHS standard.

#### Applications:

- 1. TV set
- 2. Monitor
- 3. Telephone
- 4. Computer
- 5. Circuit board

#### Package dimensions



#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.25mm (0.01") unless otherwise specified.
- 3. Lead spacing is measured where the leads emerge from the package.
- 4. Specifications are subject to change without notice.

### ■ Absolute Maximum Ratings(Ta=25°C)

Parameter	Symbol	Rating	Unit
Power Dissipation	Pd	80	mW
Forward Current	l <sub>F</sub>	30	mA
Peak Forward Current*1	I <sub>FP</sub>	150	mA
Reverse Voltage	V <sub>R</sub>	5	V
Operating Temperature	Topr	-40℃~85℃	
Storage Temperature	Tstg	-40℃~85℃	

\*1Condition for I<sub>FP</sub> is pulse of 1/10 duty and 0.1msec width.



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#### ■ Electrical and optical characteristics(Ta=25°C)

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage	$V_{F}$	I <sub>F</sub> =20mA	-	2.2	2.6	V
Luminous Intensity	lv	I <sub>F</sub> =20mA	-	80	-	mcd
Reverse Current	I <sub>R</sub>	V <sub>R</sub> =5V	-	-	100	μΑ
Peak Wave Length	λр	I <sub>F</sub> =20mA	-	568	-	nm
Dominant Wave Length	λd	I <sub>F</sub> =20mA	560	-	574	nm
Spectral Line Half-width	Δλ	I <sub>F</sub> =20mA	-	30	-	nm
Viewing Angle	2θ <sub>1/2</sub>	I <sub>F</sub> =20mA	-	30	-	deg

#### Typical electro-optical characteristics curves

Fig.1 Relative intensity vs. Wavelength

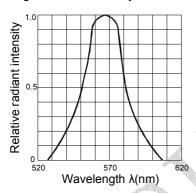


Fig.3 Forward current vs. Forward voltage

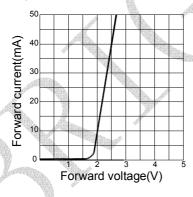


Fig.5 Relative luminous intensity

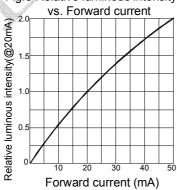


Fig.2 Forward current derating curve

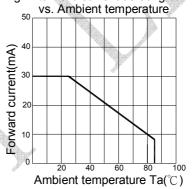


Fig.4 Relative luminous intensity

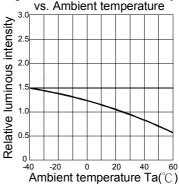
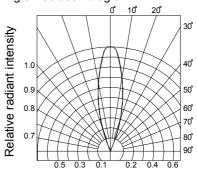


Fig.6 Radiation diagram





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#### Bin Limits

1. Intensity Bin Limits (At I<sub>F</sub>= 20mA)

Bin Code	Min. (mcd)	Max. (mcd)
М	28	42
N	42	63
Р	63	94
Q	94	140
R	140	210

● Bin: x

Intensity bin code

NOTES:1.Tolerance of measurement of luminous intensity.

:±15%



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#### Reliability Test

Classification	Test Item	Reference Standard	Test Conditions	Result
Endurance	Operation Life	MIL-STD-750:1026 MIL-STD-883:1005 JIS-C-7021 :B-1	I <sub>F</sub> =20mA Ta=+25°ℂ±5°ℂ Test time=1,000hrs	0/32
	High Temperature High Humidity Storage	MIL-STD-202:103B JIS-C-7021 :B-11	Ta=+85°C±5°C RH=90%-95% Test time=240hrs	0/32
Test	High Temperature Storage	MIL-STD-883:1008 JIS-C-7021 :B-10	High Ta=+85°C±5°C Test time=1,000hrs	0/32
	Low Temperature Storage	JIS-C-7021 :B-12	Low Ta=-45°C±5°C Test time=1,000hrs	0/32
	Temperature Cycling	MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1010 JIS-C-7021 :A-4	Ta: $+85^{\circ}$ (30min) ~ $+25^{\circ}$ (5min) ~ $-45^{\circ}$ (30min) ~ $+25^{\circ}$ (5min)  Test Time : 70min/ctcle 10cycle	0/32
Environmental	Thermal Shock	MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1011	-45°C±5°C ~+85°C±5°C 20min 20min Test Time=10cycle	0/32
Test	Solder Resistance	MIL-STD-202:201A MIL-STD-750:2031 JIS-C-7021 :A-1	Preheating: 120℃,within 120-180 sec. Operation heating: 255℃±5℃ within 5 sec.260℃ (Max)	0/32
	Solderability	MIL-STD-202F:208D MIL-STD-750D:2026 MIL-STD-883D:2003 JIS C 7021:A-2	T.sol=230±5°C Dwell Time=5±1secs	0/32

### Judgment criteria of failure for the reliability

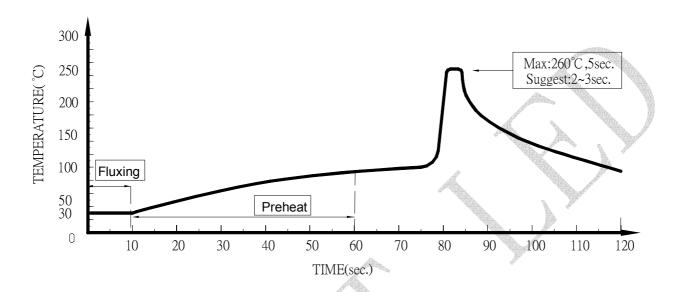
Measuring items	Symbol	Measuring conditions	Judgment criteria for failure	
Forward voltage V <sub>F</sub> (V)		I <sub>F</sub> =20mA	Over U <sup>1</sup> x1.2	
Reverse current	I <sub>R</sub> (uA)	V <sub>R</sub> =5V	Over U <sup>1</sup> x2	
Luminous intensity	lv ( mcd)	I <sub>F</sub> =20mA	Below S <sup>1</sup> X0.5	

Note: 1. U means the upper limit of specified characteristics. S means initial value.

2. Measurment shall be taken between 2 hours and after the test pieces have been returned to normal ambient conditions after completion of each test.

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#### Dip Soldering



- 1. Please avoid any external stress applied to the lead-frames and epoxy while the LEDs are at high temperature, especially during soldering
- 2. DIP soldering and hand soldering should not be done more than one time.
- 3. After soldering, avoid the epoxy lens from mechanical shock or vibration until the LEDs are back to room temerature.
- 4. Avoid rapid cooling during temperature ramp-down process
- 5. Although the soldering condition is recommended above, soldering at the lowest possible temperature is feasible for the LEDs

#### ● IRON Soldering

300 $^{\circ}$  Within 3 sec.,One time only.